

# FM120-MS THRU FM1200-MS

## List

|                                                         |   |
|---------------------------------------------------------|---|
| List.....                                               | 1 |
| Package outline.....                                    | 2 |
| Features.....                                           | 2 |
| Mechanical data.....                                    | 2 |
| Maximum ratings .....                                   | 2 |
| Rating and characteristic curves.....                   | 3 |
| Pinning information.....                                | 4 |
| Marking.....                                            | 4 |
| Suggested solder pad layout.....                        | 4 |
| Packing information.....                                | 5 |
| Reel packing.....                                       | 6 |
| Suggested thermal profiles for soldering processes..... | 6 |
| High reliability test capabilities.....                 | 7 |

# FM120-MS THRU FM1200-MS

## 1.0A Surface Mount Schottky Barrier Rectifiers - 20V-200V

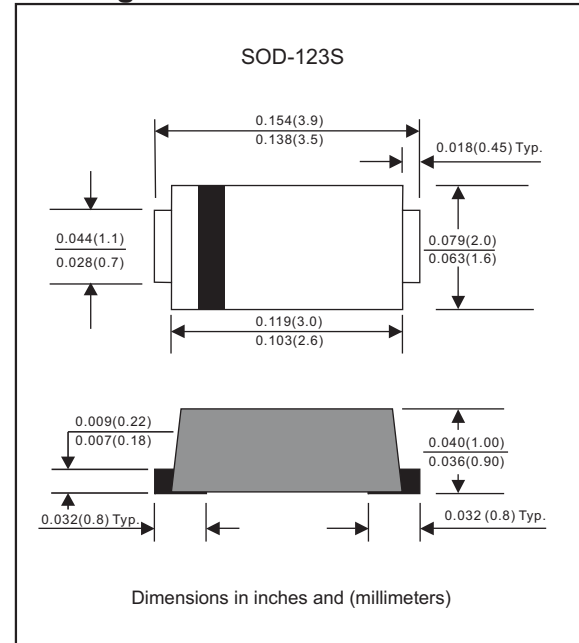
### Features

- Batch process design, excellent power dissipation offers better reverse leakage current and thermal resistance.
- Low profile surface mounted application in order to optimize board space.
- Tiny plastic SMD package.
- Low power loss, high efficiency.
- High current capability, low forward voltage drop.
- High surge capability.
- Guardring for overvoltage protection.
- Ultra high-speed switching.
- Silicon epitaxial planar chip, metal silicon junction.
- Lead-free parts meet environmental standards of MIL-STD-19500 /228
- Suffix "-H" indicates Halogen free parts, ex. FM120-MS-H.

### Mechanical data

- Epoxy : UL94-V0 rated flame retardant
- Case : Molded plastic, SOD-123S/MINI SMA
- Terminals :Plated terminals, solderable per MIL-STD-750, Method 2026
- Polarity : Indicated by cathode band
- Mounting Position : Any
- Weight : Approximated 0.0155 gram

### Package outline



### Maximum ratings and Electrical Characteristics (AT $T_A=25^{\circ}\text{C}$ unless otherwise noted)

| PARAMETER                  | CONDITIONS                                      | Symbol          | MIN. | TYP. | MAX. | UNIT                 |
|----------------------------|-------------------------------------------------|-----------------|------|------|------|----------------------|
| Forward rectified current  | See Fig.1                                       | $I_O$           |      |      | 1.0  | A                    |
| Forward surge current      | 8.3ms single half sine-wave (JEDEC methode)     | $I_{FSM}$       |      |      | 30   | A                    |
| Reverse current            | $V_R = V_{RRM} \quad T_J = 25^{\circ}\text{C}$  | $I_R$           |      |      | 0.5  | mA                   |
|                            | $V_R = V_{RRM} \quad T_J = 100^{\circ}\text{C}$ |                 |      |      | 10   |                      |
| Thermal resistance         | Junction to ambient                             | $R_{\theta JA}$ |      | 84   |      | $^{\circ}\text{C/W}$ |
|                            | Junction to case                                | $R_{\theta JC}$ |      | 42   |      | $^{\circ}\text{C/W}$ |
| Diode junction capacitance | f=1MHz and applied 4V DC reverse voltage        | $C_J$           |      | 120  |      | pF                   |
| Storage temperature        |                                                 | $T_{STG}$       | -65  |      | +175 | $^{\circ}\text{C}$   |

| SYMBOLS   | V <sub>RRM</sub> <sup>*1</sup><br>(V) | V <sub>RMS</sub> <sup>*2</sup><br>(V) | V <sub>R</sub> <sup>*3</sup><br>(V) | V <sub>F</sub> <sup>*4</sup><br>(V) | Operating temperature<br>T <sub>J</sub> , (°C) |      |
|-----------|---------------------------------------|---------------------------------------|-------------------------------------|-------------------------------------|------------------------------------------------|------|
| FM120-MS  | 20                                    | 14                                    | 20                                  | 0.50                                | -55 to +125                                    |      |
| FM130-MS  | 30                                    | 21                                    | 30                                  |                                     |                                                |      |
| FM140-MS  | 40                                    | 28                                    | 40                                  |                                     |                                                |      |
| FM150-MS  | 50                                    | 35                                    | 50                                  | 0.70                                | -55 to +150                                    |      |
| FM160-MS  | 60                                    | 42                                    | 60                                  |                                     |                                                |      |
| FM180-MS  | 80                                    | 56                                    | 80                                  | 0.85                                |                                                |      |
| FM1100-MS | 100                                   | 70                                    | 100                                 |                                     |                                                |      |
| FM1150-MS | 150                                   | 105                                   | 150                                 |                                     |                                                | 0.90 |
| FM1200-MS | 200                                   | 140                                   | 200                                 | 0.92                                |                                                |      |

\*1 Repetitive peak reverse voltage

\*2 RMS voltage

\*3 Continuous reverse voltage

\*4 Maximum forward voltage@ $I_F=1.0\text{A}$

## Rating and characteristic curves (FM120-MS THRU FM1200-MS)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

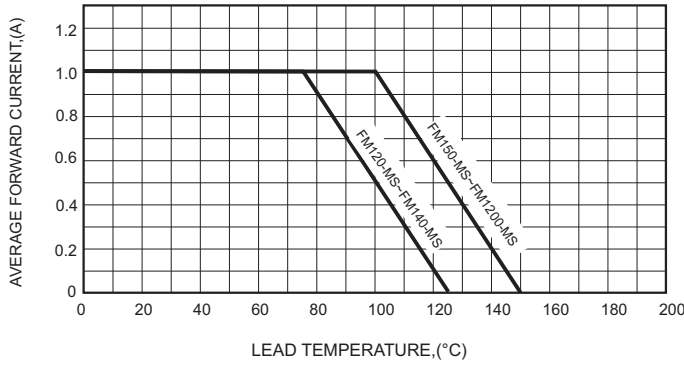


FIG.2-TYPICAL FORWARD CHARACTERISTICS

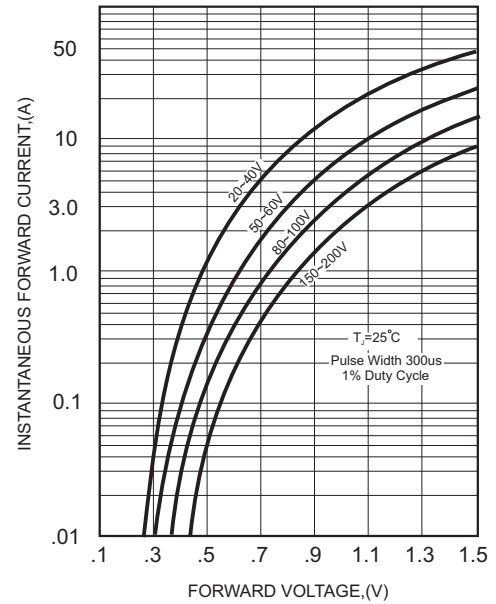


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

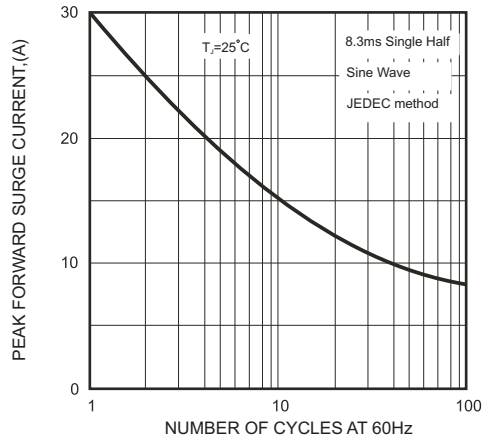


FIG.4-TYPICAL JUNCTION CAPACITANCE

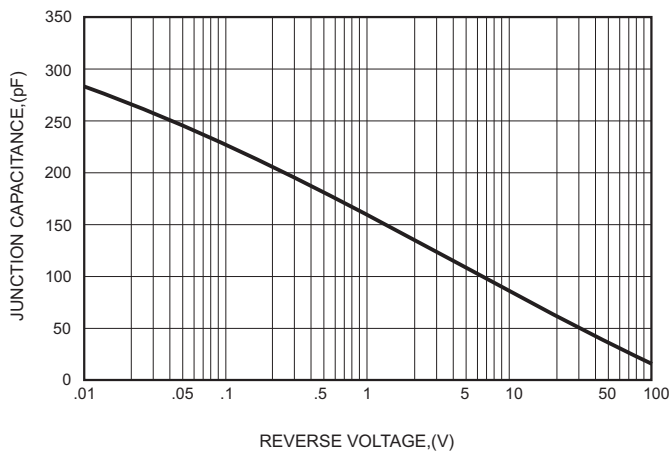
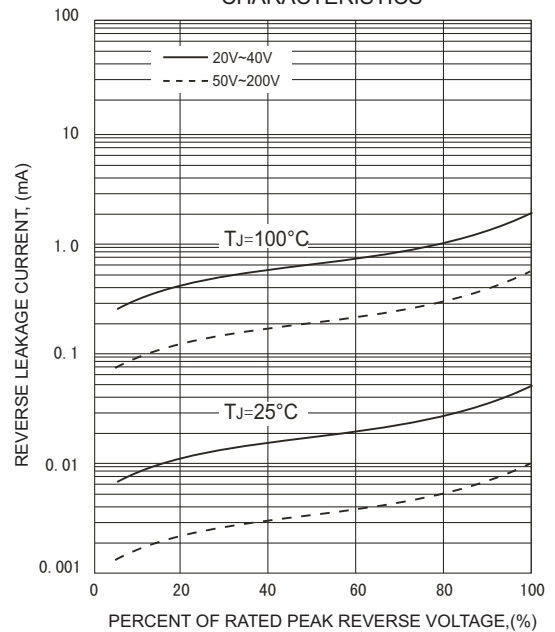


FIG.5 - TYPICAL REVERSE CHARACTERISTICS



# FM120-MS THRU FM1200-MS

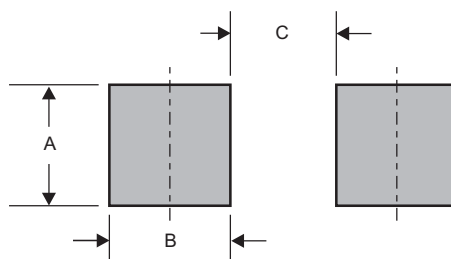
## Pinning information

| Pin                        | Simplified outline                                                                | Symbol                                                                              |
|----------------------------|-----------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|
| Pin1 cathode<br>Pin2 anode |  |  |

## Marking

| Type number | Marking code |
|-------------|--------------|
| FM120-MS    | 12           |
| FM130-MS    | 13           |
| FM140-MS    | 14           |
| FM150-MS    | 15           |
| FM160-MS    | 16           |
| FM180-MS    | 18           |
| FM1100-MS   | 10           |
| FM1150-MS   | 115          |
| FM1200-MS   | 120          |

## Suggested solder pad layout

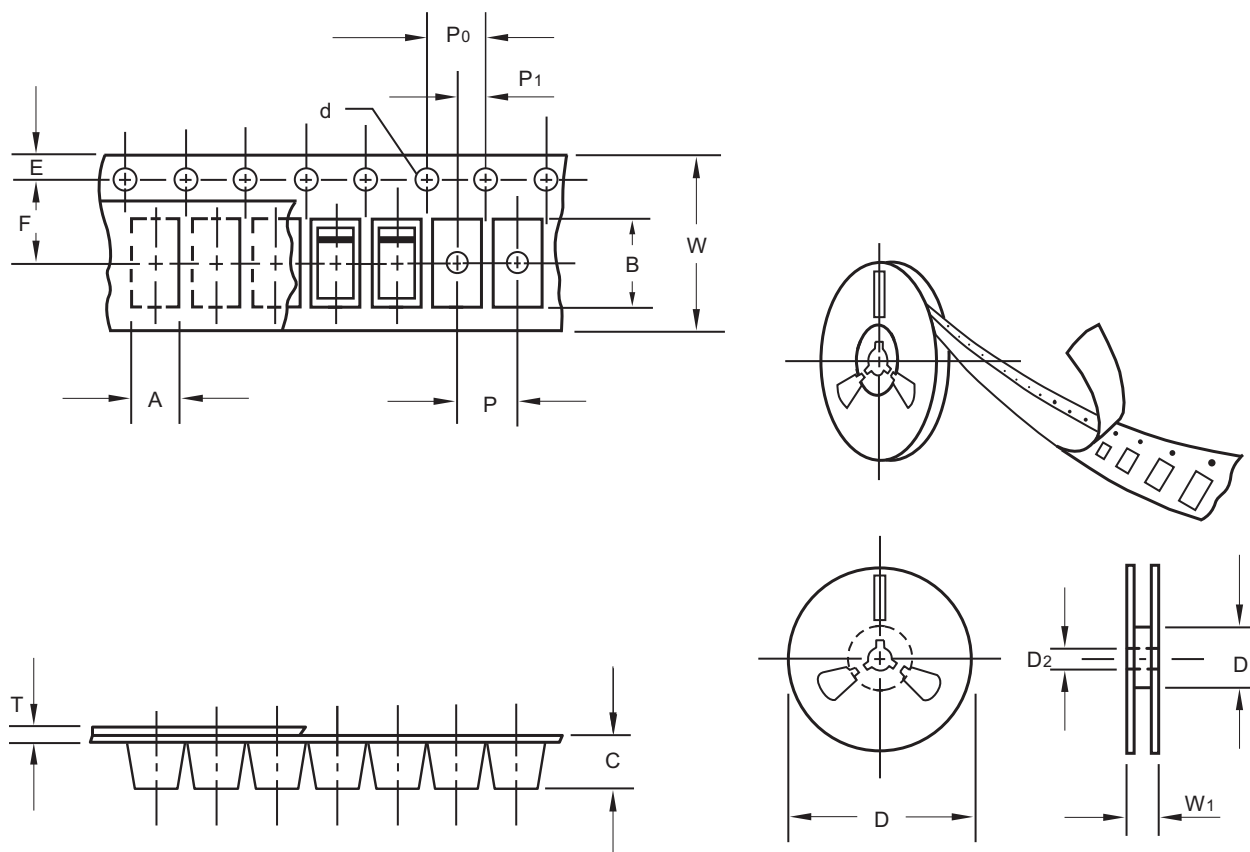


Dimensions in inches and (millimeters)

| PACKAGE  | A            | B            | C            |
|----------|--------------|--------------|--------------|
| SOD-123S | 0.044 (1.10) | 0.040 (1.00) | 0.079 (2.00) |

## FM120-MS THRU FM1200-MS

## Packing information



unit:mm

| Item                      | Symbol | Tolerance | SOD-123S |
|---------------------------|--------|-----------|----------|
| Carrier width             | A      | 0.1       | 2.00     |
| Carrier length            | B      | 0.1       | 3.85     |
| Carrier depth             | C      | 0.1       | 1.10     |
| Sprocket hole             | d      | 0.1       | 1.50     |
| 13" Reel outside diameter | D      | 2.0       | -        |
| 13" Reel inner diameter   | D1     | min       | -        |
| 7" Reel outside diameter  | D      | 2.0       | 178.00   |
| 7" Reel inner diameter    | D1     | min       | 62.00    |
| Feed hole diameter        | D2     | 0.5       | 13.00    |
| Sprocket hole position    | E      | 0.1       | 1.75     |
| Punch hole position       | F      | 0.1       | 3.50     |
| Punch hole pitch          | P      | 0.1       | 4.00     |
| Sprocket hole pitch       | P0     | 0.1       | 4.00     |
| Embossment center         | P1     | 0.1       | 2.00     |
| Overall tape thickness    | T      | 0.1       | 0.23     |
| Tape width                | W      | 0.3       | 8.00     |
| Reel width                | W1     | 1.0       | 11.40    |

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

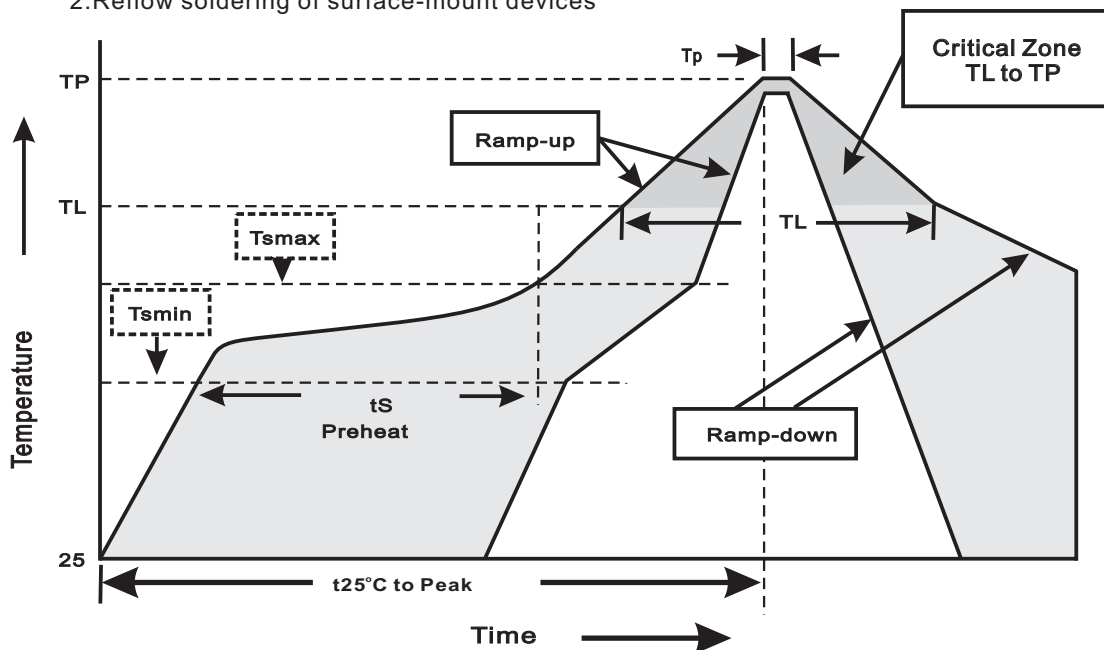
## FM120-MS THRU FM1200-MS

## Reel packing

| PACKAGE  | REEL SIZE | REEL<br>(pcs) | COMPONENT<br>SPACING<br>(m/m) | BOX<br>(pcs) | INNER<br>BOX<br>(m/m) | REEL<br>DIA,<br>(m/m) | CARTON<br>SIZE<br>(m/m) | CARTON<br>(pcs) | APPROX.<br>GROSS WEIGHT<br>(kg) |
|----------|-----------|---------------|-------------------------------|--------------|-----------------------|-----------------------|-------------------------|-----------------|---------------------------------|
| SOD-123S | 7"        | 3,000         | 4.0                           | 30,000       | 183*123*183           | 178                   | 382*257*387             | 240,000         | 9.5                             |

## Suggested thermal profiles for soldering processes

- 1.Storage environment: Temperature=5°C~40°C Humidity=55%±25%
- 2.Reflow soldering of surface-mount devices



## 3.Reflow soldering

| Profile Feature                                                                                                                 | Soldering Condition         |
|---------------------------------------------------------------------------------------------------------------------------------|-----------------------------|
| Average ramp-up rate(T <sub>L</sub> to T <sub>P</sub> )                                                                         | <3°C/sec                    |
| Preheat<br>-Temperature Min(T <sub>smmin</sub> )<br>-Temperature Max(T <sub>smmax</sub> )<br>-Time(min to max)(t <sub>s</sub> ) | 150°C<br>200°C<br>60~120sec |
| T <sub>smmax</sub> to T <sub>L</sub><br>-Ramp-upRate                                                                            | <3°C/sec                    |
| Time maintained above:<br>-Temperature(T <sub>L</sub> )<br>-Time(t <sub>L</sub> )                                               | 217°C<br>60~260sec          |
| Peak Temperature(T <sub>P</sub> )                                                                                               | 255°C-0/+5°C                |
| Time within 5°C of actual Peak Temperature(t <sub>P</sub> )                                                                     | 10~30sec                    |
| Ramp-down Rate                                                                                                                  | <6°C/sec                    |
| Time 25°C to Peak Temperature                                                                                                   | <6minutes                   |

# FM120-MS THRU FM1200-MS

## High reliability test capabilities

| Item Test                         | Conditions                                                                                                                                 | Reference                     |
|-----------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------|
| 1. Solder Resistance              | at $260\pm 5^{\circ}\text{C}$ for $10\pm 2\text{sec.}$                                                                                     | MIL-STD-750D<br>METHOD-2031   |
| 2. Solderability                  | at $245\pm 5^{\circ}\text{C}$ for 5 sec.                                                                                                   | MIL-STD-202F<br>METHOD-208    |
| 3. High Temperature Reverse Bias  | $V_R=80\%$ rate at $T_J=125^{\circ}\text{C}$ for 168 hrs.                                                                                  | MIL-STD-750D<br>METHOD-1038   |
| 4. Forward Operation Life         | Rated average rectifier current at $T_A=25^{\circ}\text{C}$ for 500hrs.                                                                    | MIL-STD-750D<br>METHOD-1027   |
| 5. Intermittent Operation Life    | $T_A = 25^{\circ}\text{C}$ , $I_F = I_O$<br>On state: power on for 5 min.<br>off state: power off for 5 min.<br>on and off for 500 cycles. | MIL-STD-750D<br>METHOD-1036   |
| 6. Pressure Cooker                | $15P_{SIG}$ at $T_A=121^{\circ}\text{C}$ for 4 hrs.                                                                                        | JESD22-A102                   |
| 7. Temperature Cycling            | $-55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ dwelled for 30 min.<br>and transferred for 5min. total 10 cycles.                          | MIL-STD-750D<br>METHOD-1051   |
| 8. Forward Surge                  | 8.3ms single half sine-wave , one surge.                                                                                                   | MIL-STD-750D<br>METHOD-4066-2 |
| 9. Humidity                       | at $T_A=85^{\circ}\text{C}$ , RH=85% for 1000hrs.                                                                                          | MIL-STD-750D<br>METHOD-1021   |
| 10. High Temperature Storage Life | at $175^{\circ}\text{C}$ for 1000 hrs.                                                                                                     | MIL-STD-750D<br>METHOD-1031   |